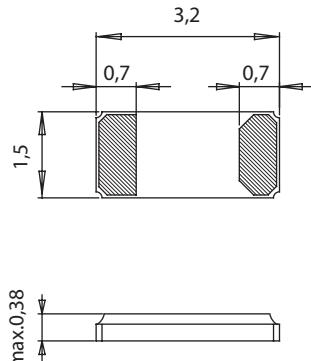


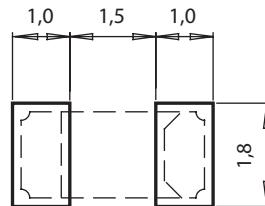
100% leadfree, RoHS - compliant

DIMENSIONS

Package:



Recommended Solder Pad:



All dimensions in mm typical

Lowest profile SMT ceramic pack.
Ultra low profile: 0.38 mm height
SMD-package in Tape and Reel
Ind. and Ext. temperature ranges
High stability
Low aging
Low power consumption
High shock and vibration resistance

DESCRIPTION:

This SMD ceramic package has been specially designed for ultra low profile telecom and smart-card applications. A special crystal manufacturing process is used to achieve improved electrical characteristics and a miniaturized blank size.

For pick-and-place equipment, the parts are available in 12 mm tape:
 7" (178 mm) reel with 3'000 crystals
 13" (330 mm) reel with 14'000 crystals

ELECTRICAL CHARACTERISTICS AT 25°C:

Nominal Frequency ¹⁾	F _L	32.768	kHz
Load capacitance ²⁾	C _L	7.0 / 9.0 / 12.5	pF
Frequency tolerance ³⁾	ΔF/F	+/-20	ppm
	ΔF/F	+/-100	ppm
Series resistance typ./max.	R _S	55 / 80	kΩ
Motional capacitance typ.	C ₁	4.4	fF
Static capacitance typ.	C ₀	1.6	pF
Drive level max.	P	0.5	μW
Insulation resistance min.	R _i	500	MΩ
Aging first year max.	ΔF/F	+/-3	ppm
Turnover temperature	T ₀	25 +/-5	°C
Frequency vs. temperature	ΔF/F ₀	-0.035 ppm/°C ² (T - T ₀) ² +/-10%	ppm

1) Other frequencies on request.

2) Other load capacitances on request.

3) Tighter and wider frequency tolerances on request.

STANDARD FREQUENCIES:

Frequency kHz
32.768
Other frequencies on request

**ENVIRONMENTAL
CHARACTERISTICS:**

		Conditions	Max. Dev.
Storage temp. range		-55 to +125°C	
Industrial operating temp. range		-40 to +85°C	
Extended operating temp. range		-55 to +125°C	
Shock resistance	ΔF/F	5000 g, 0.3 ms, ½ sine	+/-5 ppm
Vibration resistance	ΔF/F	20 g / 10–2000 Hz	+/-5 ppm

**TERMINATIONS AND
PROCESSING:**

Type	Termination	Processing
CM7V-T1A 0.4	For SMD mounting Au flashed pads	Reflow soldering 260°C / 20 s max.

**PART NUMBER/
ORDERING INFORMATION
EXAMPLE:**

<u>C</u>	<u>M</u>	<u>7</u>	<u>V</u>	<u>-</u>	<u>T</u>	<u>1</u>	<u>A</u>	<u>0.4</u>	<u>32.768 kHz</u>	<u>9.0 pF</u>	<u>+/-20 ppm</u>
Crystal package											Frequency tolerance
C = Crystal in ceramic package											
Package lid										Load capacitance C_L	
M = Metal lid											
Package size									F_L		
7 = 3.2 x 1.5 x 0.38 mm									Thickness max. 0.38 mm		
Blank									A = Pads on both ends		
V = Tuning fork									Pad plating		
									1 = Au flashed pads		
									Package type		
									T = For SMD mounting		

All specifications subject to change without notice. 10.09



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